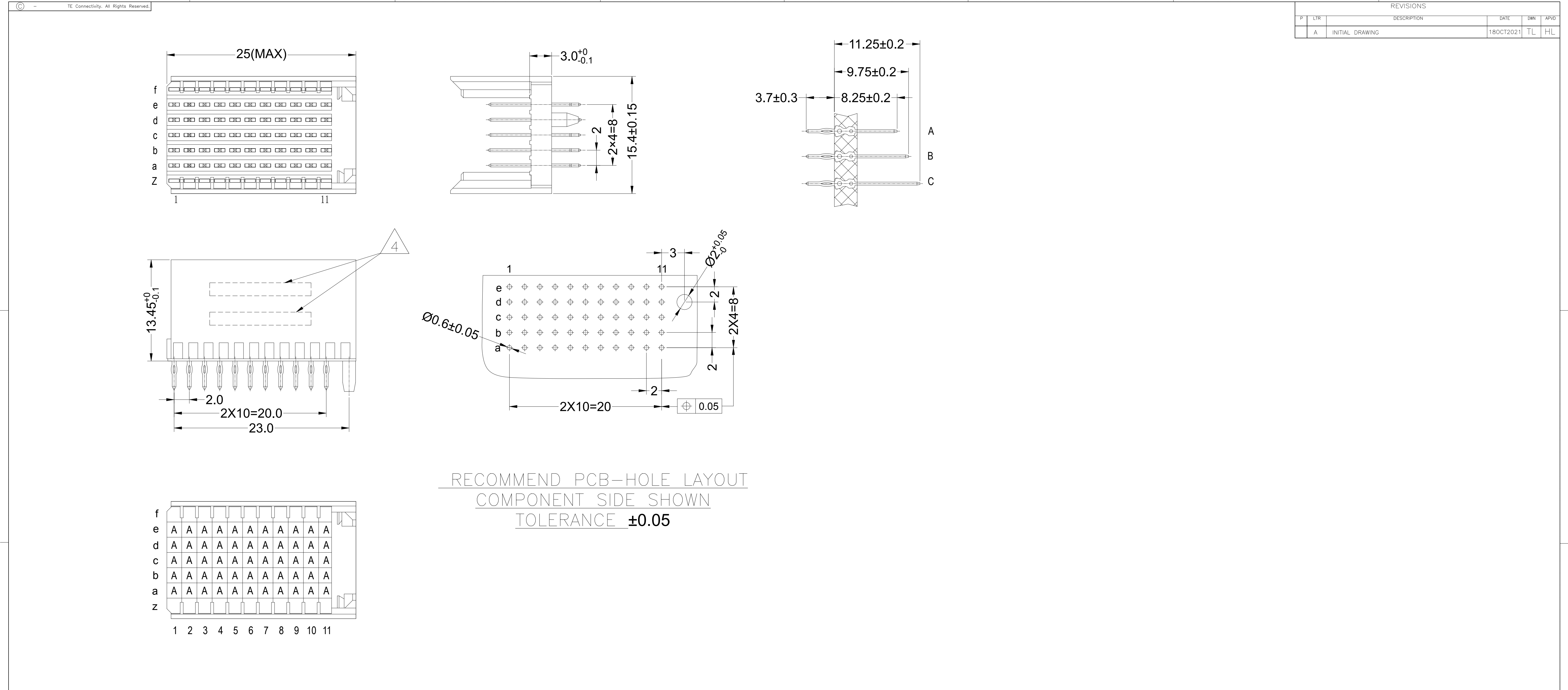




RECOMMEND PCB-HOLE LAYOUT
COMPONENT SIDE SHOWN
TOLERANCE ±0.05

- 1
- MATERIAL:
CONTACT: COPPER ALLOY.
HOUSING: GLASS-FILLED POLYESTER.
- 2
- GENERAL PLATING SPECIFICATION: UNDERPLATING
(ENTIRE CONTACT): 1.27µm MIN NICKEL AND ACTION
PIN: 0.5µm MIN TIN.
FOR PLATING OF MATING SURFACES SEE APPLICABLE
SPECIFICATION REFERENCE FOR EACH DASH NUMBER.
- 3
- CONFORMS TO ALL TESTING ACCORDING TO IEC 61076-4-101
PERFORMANCE LEVEL 2.
- 4
- CONNECTOR MARKED WITH PART NUMBER AND DATE CODE.

REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
A		INITIAL DRAWING	18OCT2021	TL	HL

23	2391904-1
FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN TONY LI 27MAY2021	TE Connectivity Ltd.		
		CHK ALEX XU 27MAY2021			
DIMENSIONS: mm		APVD HOPE LU 27MAY2021	NAME MALE ASSEMBLY, Z-PACK 2mm HM, 55P TYPE C EON		
		PRODUCT SPEC 108-19082	SIZE A1		
		APPLICATION SPEC 114-160149			
		WEIGHT 0	RESTRICTED TO —		
MATERIAL 1	FINISH SEE TABLE	CUSTOMER DRAWING		SCALE 4:1	SHEET 1 OF 1

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)